ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® MAterial Comp © Copyright 2005. I international and Par	PC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docum level parts, t	ent is a decla the declaratio	ration on enco	of the substa mpasses all	ances w lower l	ithin the manu evel materials	facturer l for whicl	listed item. h the manu	Note: if facturer l	the item is an as has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					Materials	ials and Mfg Information				
Supplier Information																
Company name* Company un			nique ID U			Unique ID Authority					R	Response Date*				
onsemi											20	2023-06-08				
Contact Name Title - Contact						Phone - Contact*					E	Email - Contact*				
Product-Env-Stewards Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				om			
Authorized Representative* Title - Representative			sentative	Phone - Representative*			E	Email - Representative*								
Product-Env-Stewards	Product Enviro Compliance			NA				P	Product-Env-Stewards@onsemi.com							
Requester Item Number	Mfr Iten	Mfr Item Number Mfr Ite		Mfr Item Name		Effective D	ate V	/ersion	Ma	Manufacturing Site		Wei	ght*	UOM	Unit Type	
	CAT872	AT872-50ULGT3 2 INPUT RESE		ГІС		2023-06-08	;					1.14	5	mg	Each	
Ianufacturing Proccess Informa	tion											1		1		
Terminal Plating / Grid Array M	aterial	Terminal Base Alloy		J-STD-020 MS	20 MSL Rating		Peak Process Body Temperature		Max Time at	ax Time at Peak Temperat		Numbe	er of Reflow Cyc	cles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С		30		seconds 3				
omments																
vel 1 - maximum time at peak temperati	ire during so	dering is 10-3	0 seconds													
or more information regarding material	composition	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter a value [F] Optionally enter the positive (+) and negative					
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.073	mg	Supplier	Silicon (Si)	7440-21-3		0.073	mg	
Die Attach	0.032	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.0112	mg	
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0208	mg	
Mold Compound-Black	0.84	mg		Epoxy Phenol Resin	proprietary data		0.0756	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.7644	mg	
Plating	0.16	mg	Supplier	Palladium (Pd)	7440-05-3		0.0048	mg	
			В	Nickel (Ni)	7440-02-0		0.1536	mg	
			Supplier	Gold (Au)	7440-57-5		0.0016	mg	
Wire Bond - Au	0.04	mg	Supplier	Gold (Au)	7440-57-5		0.04	mg	